



# **ULTRAFAST SOFT RECOVERY RECTIFIER DIODE**

# **PRODUCT APPLICATIONS**

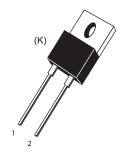
- Anti-Parallel Diode
   -Switchmode Power Supply
  - -Inverters
- Free Wheeling Diode
  - -Motor Controllers
  - -Converters
  - -Inverters
- Snubber Diode
- PFC

## **PRODUCT FEATURES**

- Ultrafast Recovery Times
- Soft Recovery Characteristics
- Popular TO-220 Package
- · Low Forward Voltage
- Low Leakage Current
- Avalanche Energy Rated

### **PRODUCT BENEFITS**

- Low Losses
- · Low Noise Switching
- Cooler Operation
- Higher Reliability Systems
- Increased System Power Density





- 1 Cathode
- 2 Anode Back of Case - Cathode

### **MAXIMUM RATINGS**

All Ratings:  $T_C = 25^{\circ}C$  unless otherwise specified.

Symbol	Characteristic / Test Conditions	APT15DQ100K(G)	UNIT	
V <sub>R</sub>	Maximum D.C. Reverse Voltage			
V <sub>RRM</sub>	Maximum Peak Repetitive Reverse Voltage	1000	Volts	
V <sub>RWM</sub>	Maximum Working Peak Reverse Voltage			
I <sub>F(AV)</sub>	Maximum Average Forward Current (T <sub>C</sub> = 126°C, Duty Cycle = 0.5)	15		
I <sub>F(RMS)</sub>	RMS Forward Current (Square wave, 50% duty)	29	Amps	
I <sub>FSM</sub>	Non-Repetitive Forward Surge Current $(T_J = 45^{\circ}C, 8.3 \text{ms})$	80		
E <sub>AVL</sub>	Avalanche Energy (1A, 40mH)	20	mJ	
T <sub>J</sub> ,T <sub>STG</sub>	Operating and StorageTemperature Range	-55 to 175	Ĵ	
T <sub>L</sub>	Lead Temperature for 10 Sec.	300		

## STATIC ELECTRICAL CHARACTERISTICS

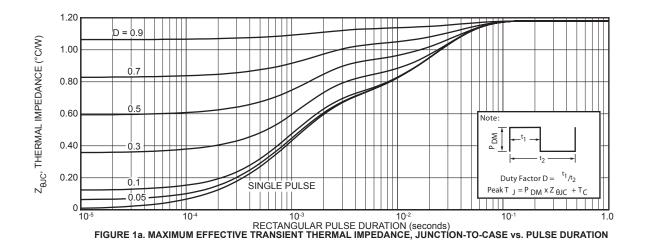
Symbol	Characteristic / Test Conditions		MIN	TYP	MAX	UNIT
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 15A		2.5	3.0	Volts
		I <sub>F</sub> = 30A		3.06		
		I <sub>F</sub> = 15A, T <sub>J</sub> = 125°C		1.92		
I <sub>RM</sub>	Maximum Reverse Leakage Current	V <sub>R</sub> = 1000V			100	- μΑ
		V <sub>R</sub> = 1000V, T <sub>J</sub> = 125°C			500	
C <sub>T</sub>	Junction Capacitance, V <sub>R</sub> = 200V			12		pF

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
t <sub>rr</sub>	Reverse Recovery Time $I_F = 1A$ , $di_F/dt =$	$-100A/\mu s$ , $V_R = 30V$ , $T_J = 25^{\circ}C$	-	20		ns
t <sub>rr</sub>	Reverse Recovery Time	$I_F = 15A$ , $di_F/dt = -200A/\mu s$ $V_R = 667V$ , $T_C = 25^{\circ}C$	-	235		115
Q <sub>rr</sub>	Reverse Recovery Charge		-	185		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		-	3	-	Amps
t <sub>rr</sub>	Reverse Recovery Time	$I_F = 15A$ , $di_F/dt = -200A/\mu s$ $V_R = 667V$ , $T_C = 125°C$	-	300		ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	810		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		-	6	-	Amps
t <sub>rr</sub>	Reverse Recovery Time	$I_F = 15A$ , $di_F/dt = -1000A/\mu s$ $V_R = 667V$ , $T_C = 125°C$	-	125		ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	1150		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		-	19		Amps

# THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
R <sub>θJC</sub>	Junction-to-Case Thermal Resistance			1.18	°C/W
W <sub>T</sub>	Package Weight		0.07		oz
			1.9		g
Torque	Maximum Mounting Torque			10	lb•in
				1.1	N•m

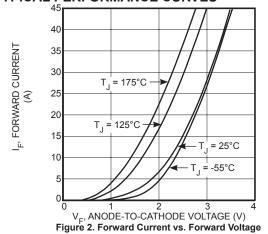
 $\label{lem:microsemi} \textbf{Microsemi reserves the right to change, without notice, the specifications and information contained herein.}$ 



Dissipated Power (Watts)

Dissipated Power (

### **TYPICAL PERFORMANCE CURVES**



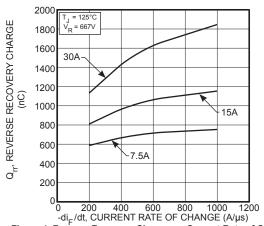
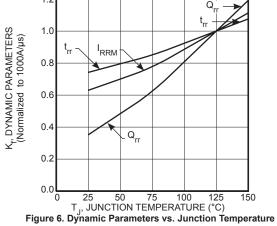
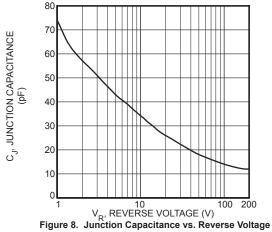


Figure 4. Reverse Recovery Charge vs. Current Rate of Change





# APT15DQ100K(G)

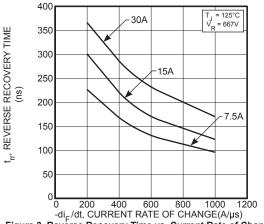


Figure 3. Reverse Recovery Time vs. Current Rate of Change

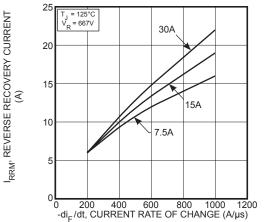


Figure 5. Reverse Recovery Current vs. Current Rate of Change

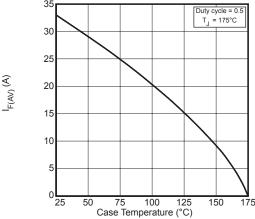


Figure 7. Maximum Average Forward Current vs. CaseTemperature

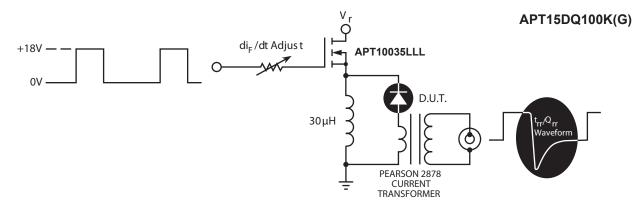
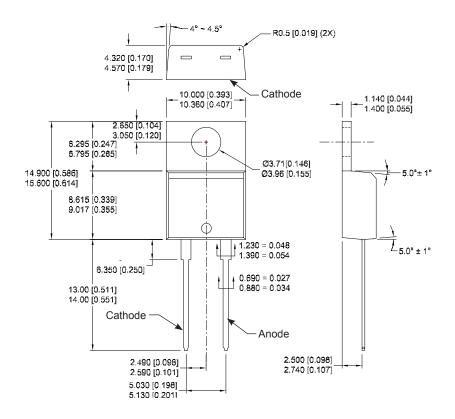


Figure 9. Diode Test Circuit

- I<sub>F</sub> Forward Conduction Current
   di<sub>F</sub>/dt Rate of Diode Current Change Through Zero Crossing.
   I<sub>RRM</sub> Maximum Reverse Recovery Current
   t<sub>rr</sub> Reverse Recovery Time measured from zero crossing where diode current goes from positive to negative, to the point at which the straight line through I<sub>RRM</sub> and 0.25, I<sub>RRM</sub> passes through zero.
- $oldsymbol{\mathsf{Q}}_{\mathsf{rr}}$  Area Under the Curve Defined by  $\mathsf{I}_{\mathsf{RRM}}$  and  $\mathsf{t}_{\mathsf{RR}}$

Figure 10. Diode Reverse Recovery Waveform Definition

# TO-220 (K) Package Outline e3 100% Sn



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